ANALOG DEVICES

Dual SPDT Switch
ADG436

FEATURES
44 V Supply Maximum Ratings
V_{SS} to V_{DD} Analog Signal Range
Low On Resistance (12 Ω typ)
Low ΔR_{ON} (3 Ω max)
Low R_{ON} Match (2.5 Ω max)
Low Power Dissipation
Fast Switching Times
    t_{ON} < 175 ns
    t_{OFF} < 145 ns
Low Leakage Currents (5 nA max)
Low Charge Injection (10 pC max)
Break-Before-Make Switching Action

APPLICATIONS
Audio and Video Switching
Battery Powered Systems
Test Equipment
Communications Systems

FUNCTIONAL BLOCK DIAGRAM
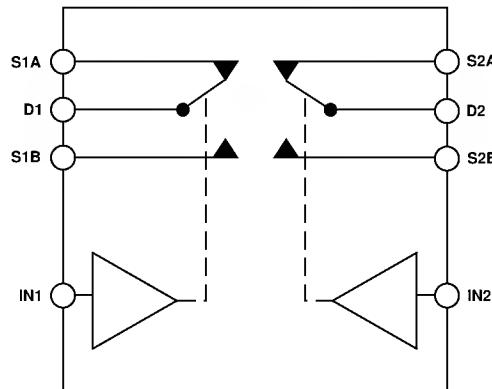
GENERAL DESCRIPTION
The ADG436 is a monolithic CMOS device comprising two independently selectable SPDT switches. It is designed on an LC^2MOS process which provides low power dissipation yet gives high switching speed and low on resistance.

The on resistance profile is very flat over the full analog input range ensuring good linearity and low distortion when switching audio signals. High switching speed also makes the part suitable for video signal switching. CMOS construction ensures ultralow power dissipation making the part ideally suited for portable and battery powered instruments.

Each switch conducts equally well in both directions when ON and has an input signal range which extends to the power supplies. In the OFF condition, signal levels up to the supplies are blocked. All switches exhibit break-before-make switching action for use in multiplexer applications. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

PRODUCT HIGHLIGHTS
1. Extended Signal Range
   The ADG436 is fabricated on an enhanced LC^2MOS process, giving an increased signal range which extends to the supply rails.

2. Low Power Dissipation

3. Low R_{ON}

4. Single Supply Operation
   For applications where the analog signal is unipolar, the ADG436 can be operated from a single rail power supply.

REV. 0

ADG436– SPECIFICATIONS[1]

Dual Supply (V_{DD} = +15 V, V_{SS} = –15 V, GND = 0 V, unless otherwise noted)

Parameter	+25°C	–40°C to +85°C	Units	Test Conditions/ Comments
ANALOG SWITCH				
Analog Signal Range		V_{SS} to V_{DD}	V	
R_{ON}	12		Ω typ	$V_D = \pm10$ V, $I_S = -1$ mA
		25	Ω max	
ΔR_{ON}	1		Ω typ	$V_D = -5$ V, 5 V, $I_S = -10$ mA
		3	Ω max	
R_{ON} Match	1		Ω typ	$V_D = \pm10$ V, $I_S = -10$ mA
		2.5	Ω max	
LEAKAGE CURRENTS				$V_{DD} = +16.5$ V, $V_{SS} = -16.5$ V
Source OFF Leakage I_S (OFF)	±0.005		nA typ	$V_D = \pm15.5$ V, $V_S = \pm15.5$ V
	±0.25	±5	nA max	Test Circuit 2
Channel ON Leakage I_D, I_S (ON)	±0.05		nA typ	$V_S = V_D = \pm15.5$ V
	±0.4	±5	nA max	Test Circuit 3
DIGITAL INPUTS				
Input High Voltage, V_{INH}		2.4	V min	
Input Low Voltage, V_{INL}		0.8	V max	
Input Current				
I_{INL} or I_{INH}		±0.005	μA typ	$V_{IN} = 0$ V or V_{DD}
		±0.5	μA max	
DYNAMIC CHARACTERISTICS[2]				
t_{ON}	70		ns typ	$R_L = 300$ Ω, $C_L = 35$ pF;
		125	ns max	$V_S = \pm10$ V; Test Circuit 4
t_{OFF}	60		ns typ	$R_L = 300$ Ω, $C_L = 35$ pF;
		120	ns max	$V_S = \pm10$ V; Test Circuit 4
Break-Before-Make Delay, t_{OPEN}	10		ns min	$R_L = 300$ Ω, $C_L = 35$ pF; $V_S = +5$ V; Test Circuit 5
Charge Injection	10		pC typ	$V_D = 0$ V, $R_D = 0$ Ω, $C_L = 10$ nF; Test Circuit 6;
OFF Isolation	72		dB typ	$R_L = 75$ Ω, $C_L = 5$ pF, $f = 1$ MHz; $V_S = 2.3$ V rms, Test Circuit 7
Channel-to-Channel Crosstalk	90		dB typ	$R_L = 75$ Ω, $C_L = 5$ pF, $f = 1$ MHz; $V_S = 2.3$ V rms, Test Circuit 8
C_S (OFF)	10		pF typ	
C_D, C_S (ON)	30		pF typ	
POWER REQUIREMENTS				
I_{DD}	0.05		mA typ	Digital Inputs = 0 V or 5 V
		0.35	mA max	
I_{SS}	0.01		μA typ	
	1	5	μA max	
V_{DD}/V_{SS}		±3/±20	V min/V max	$|V_{DD}| = |V_{SS}|$

NOTES
[1]Temperature Range is as follows: B Version, –40°C to +85°C.
[2]Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

Single Supply (V_{DD} = +12 V, V_{SS} = 0 V, GND = 0 V, unless otherwise noted)

Parameter	+25°C	–40°C to +85°C	Units	Test Conditions/ Comments
ANALOG SWITCH				
Analog Signal Range		0 to V_{DD}	V	
R_{ON}	20		Ω typ	V_D = +1 V, +10 V, I_S = –1 mA
		40	Ω max	
R_{ON} Match		2.5	Ω max	
LEAKAGE CURRENTS				V_{DD} = +13.2 V
Source OFF Leakage I_S (OFF)	±0.005		nA typ	V_D = 12.2 V/1 V, V_S = 1 V/12.2 V
	±0.25	±5	nA max	Test Circuit 2
Channel ON Leakage I_D, I_S (ON)	±0.05		nA typ	$V_S = V_D$ = 12.2 V/1 V
	±4	±5	nA max	Test Circuit 3
DIGITAL INPUTS				
Input High Voltage, V_{INH}		2.4	V min	
Input Low Voltage, V_{INL}		0.8	V max	
Input Current				
I_{INL} or I_{INH}		±0.005	µA typ	V_{IN} = 0 V or V_{DD}
		±0.5	µA max	
DYNAMIC CHARACTERISTICS[2]				
t_{ON}	100		ns typ	R_L = 300 Ω, C_L = 35 pF;
		200	ns max	V_S = +8 V; Test Circuit 4
t_{OFF}	90		ns typ	R_L = 300 Ω, C_L = 35 pF;
		180	ns max	V_S = +8 V; Test Circuit 4
Break-Before-Make Delay, t_{OPEN}	10		ns typ	R_L = 300 Ω, C_L = 35 pF;
				V_S = +5 V; Test Circuit 5
Charge Injection	10		pC typ	V_D = 6 V, R_D = 0 Ω, C_L = 10 nF;
				Test Circuit 6
OFF Isolation	72		dB typ	R_L = 75 Ω, C_L = 5 pF, f = 1 MHz;
				V_S = 1.15 V rms; Test Circuit 7
Channel-to-Channel Crosstalk	90		dB typ	R_L = 75 Ω, C_L = 5 pF, f = 1 MHz;
				V_S = 1.15 V rms, Test Circuit 8
C_S (OFF)	10		pF typ	
C_D, C_S (ON)	30		pF typ	
POWER REQUIREMENTS				V_{DD} = +13.5 V
I_{DD}	0.05		mA typ	Digital Inputs = 0 V or 5 V
		0.35	mA max	
V_{DD}		+3/+30	V min/V max	

NOTES
[1]Temperature range is as follows: B Version, –40°C to +85°C.
[2]Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

ADG436

ABSOLUTE MAXIMUM RATINGS[1]
(T_A = +25°C unless otherwise noted)

V_{DD} to V_{SS} . . . . +44 V
V_{DD} to GND . . . . –0.3 V to +30 V
V_{SS} to GND . . . . +0.3 V to –30 V
Analog, Digital Inputs[2] . . . . V_{SS} – 2 V to V_{DD} + 2 V
or 20 mA, whichever occurs first
Continuous Current, S or D . . . . 20 mA
Peak Current, S or D . . . . 40 mA
(Pulsed at 1 ms, 10% Duty Cycle max)
Operating Temperature Range
Industrial (B Version) . . . . –40°C to +85°C
Storage Temperature Range . . . . –65°C to +125°C
Junction Temperature . . . . +150°C
Plastic DIP Package
θ_{JA}, Thermal Impedance . . . . 117°C/W
Lead Temperature, Soldering (10 sec) . . . . +260°C

SOIC Package
θ_{JA}, Thermal Impedance . . . . 77°C/W
Lead Temperature, Soldering
Vapor Phase (60 sec) . . . . +215°C
Infrared (15 sec) . . . . +220°C

NOTES
[1]Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.
[2]Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG436 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



ADG436 Truth Table

Logic	Switch A	Switch B
0	OFF	ON
1	ON	OFF

ORDERING GUIDE

Model	Temperature Range	Package Option*
ADG436BN	–40°C to +85°C	N-16
ADG436BR	–40°C to +85°C	R-16A

*N = Plastic DIP, R-16A = 0.15" Small Outline IC (SOIC).

REV. 0

TERMINOLOGY

V_{DD}	Most positive power supply potential.
V_{SS}	Most negative power supply potential in dual supplies. In single supply applications, it may be connected to ground.
GND	Ground (0 V) reference.
S	Source terminal. May be an input or output.
D	Drain terminal. May be an input or output.
IN	Logic control input.
R_{ON}	Ohmic resistance between D and S.
ΔR_{ON}	R_{ON} variation due to a change in the analog input voltage with a constant load current.
R_{ON} Match	Difference between the R_{ON} of any two channels.
I_S (OFF)	Source leakage current with the switch "OFF."
I_D (OFF)	Drain leakage current with the switch "OFF."
I_D, I_S (ON)	Channel leakage current with the switch "ON."
V_D (V_S)	Analog voltage on terminals D, S.
C_S (OFF)	"OFF' switch source capacitance.
C_D (OFF)	"OFF' switch drain capacitance.
C_D, C_S (ON)	"ON' switch capacitance.

t_{ON}	Delay between applying the digital control input and the output switching on.
t_{OFF}	Delay between applying the digital control input and the output switching off.
t_{OPEN}	Break-before-make delay when switches are configured as a multiplexer.
V_{INL}	Maximum input voltage for logic "0."
V_{INH}	Minimum input voltage for logic "1."
I_{INL} (I_{INH})	Input current of the digital input.
Crosstalk	A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.
Off	A measure of unwanted signal coupling through an "OFF" switch.
Charge Injection	A measure of the glitch impulse transferred from the digital input to the analog output during switching.
I_{DD}	Positive supply current.
I_{SS}	Negative supply current.

PIN CONFIGURATION
(DIP/SOIC)

```
        IN1 [1]  ●        [16] NC
        S1A [2]           [15] NC
         D1 [3]           [14] NC
        S1B [4]  ADG436   [13] VDD
        VSS [5]  TOP VIEW [12] S2B
                (Not to Scale)
        GND [6]           [11] D2
         NC [7]           [10] S2A
         NC [8]           [9]  IN2
```

NC = NO CONNECT
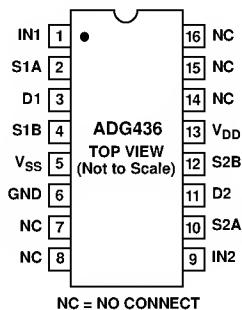
ADG436– Typical Performance Graphs
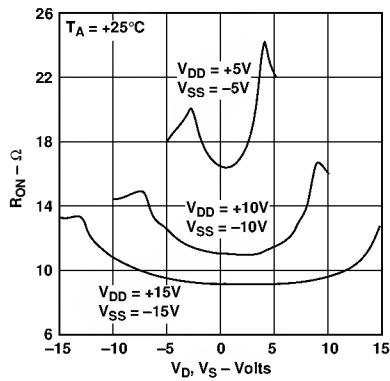
Figure 1. R_{ON} as a Function of V_D (V_S): Dual Supply
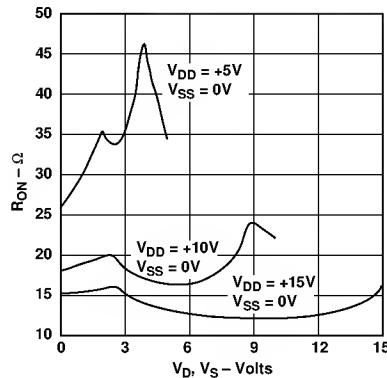

Figure 2. R_{ON} as a Function of V_D (V_S): Single Power Supply
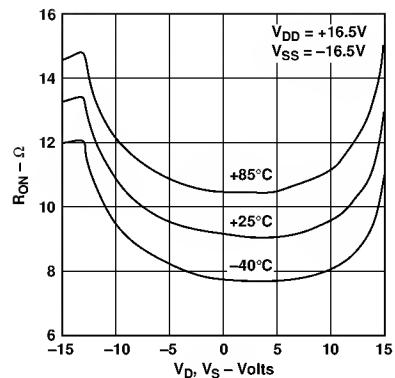

Figure 3. R_{ON} as a Function of V_D (V_S) for Different Temperatures: Dual Supply
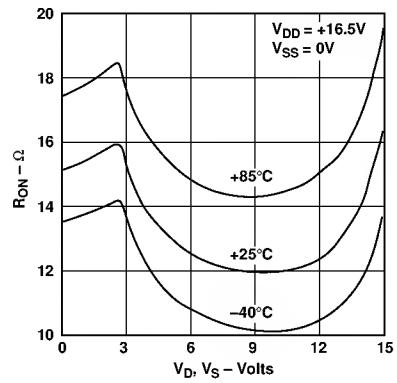

Figure 4. R_{ON} as a Function of V_D (V_S) for Different Temperatures: Single Supply
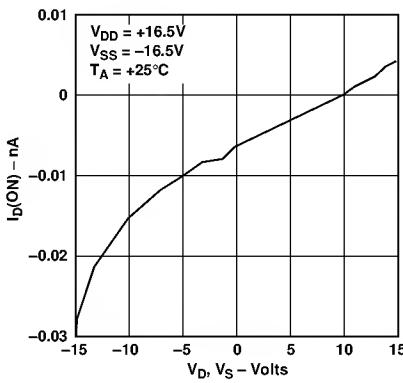
Figure 5. I_D (ON) Leakage Current as a Function of V_D (V_S): Dual Supply
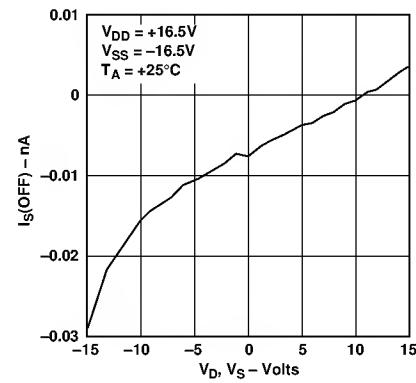
Figure 6. I_S (OFF) Leakage Current as a Function of V_D (V_S): Dual Supply
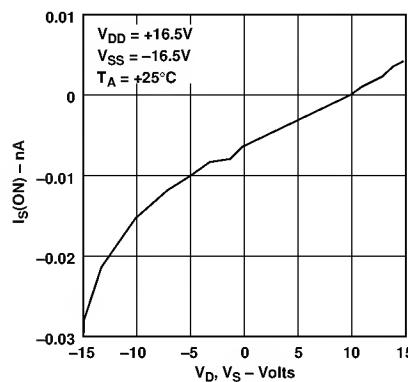
Figure 7. I_S (ON) Leakage Current as a Function of V_D (V_S): Dual Supply
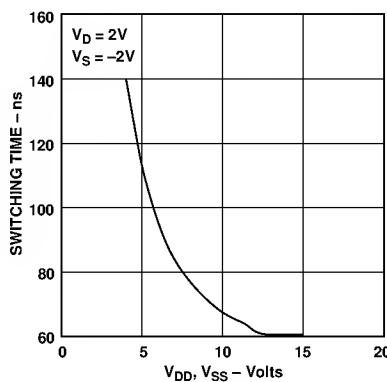
Figure 8. Switching Time as a Function of V_D (V_S): Dual Supply
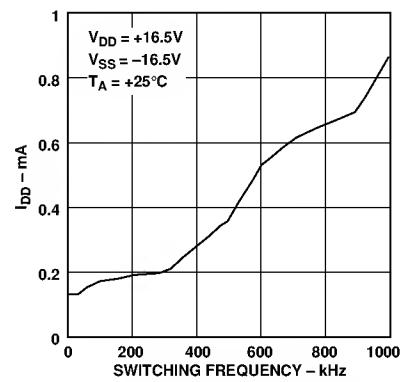
Figure 9. I_{DD} as a Function of Switching Frequency: Dual Supply
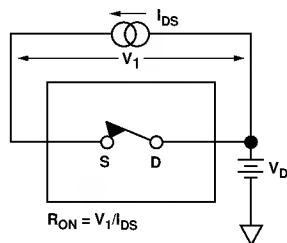
Test Circuit 1. On Resistance
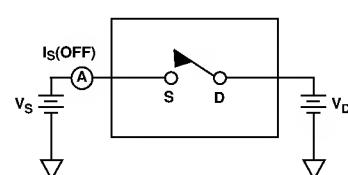
Test Circuit 2. Off Leakage



NC = NO CONNECT
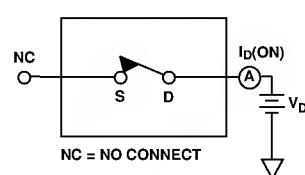
Test Circuit 3. On Leakage
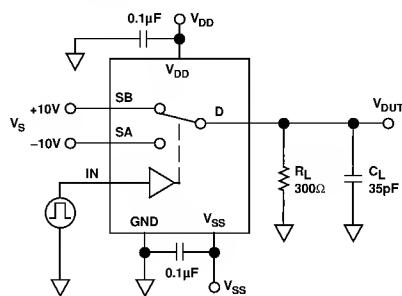
Test Circuit 4. Switching Times
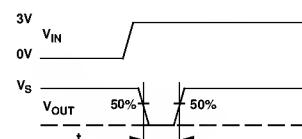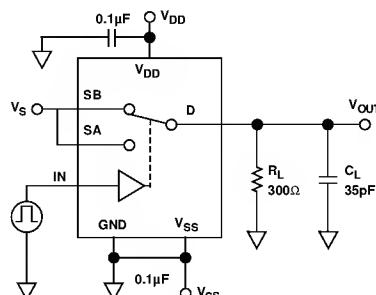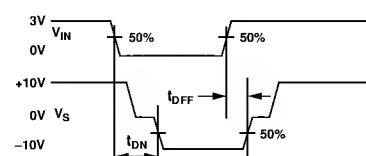

Test Circuit 5. Break-Before-Make Delay, t_{OPEN}
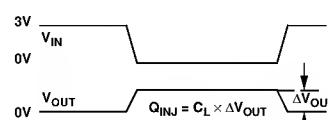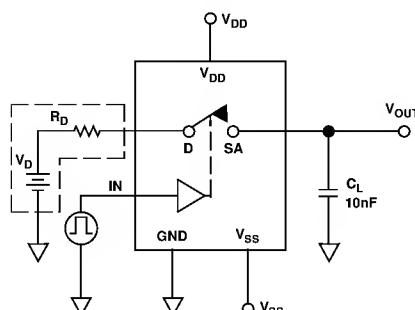
Test Circuit 6. Charge Injection
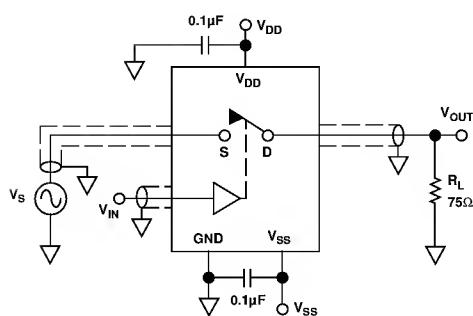
Test Circuit 7. Off Isolation

CHANNEL-TO-CHANNEL
CROSSTALK
$20 \times Log |V_S/V_{OUT}|$
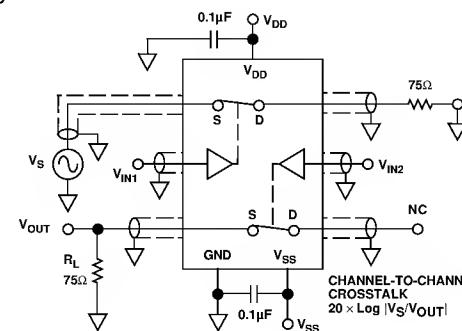
Test Circuit 8. Channel-to-Channel Crosstalk

ADG436

APPLICATIONS INFORMATION

ADG436 Supply Voltages

The ADG436 can operate off a dual or single supply. V_{SS} should be connect to GND when operating with a single supply. When using a dual supply, the ADG436 can also operate with unbalanced supplies, for example $V_{DD} = 20$ V and $V_{SS} = -5$ V. The only restrictions are that V_{DD} to GND must not exceed 30 V, V_{SS} to GND must not drop below -30 V and V_{DD} to V_{SS} must not exceed $+44$ V. It is important to remember that the ADG436 supply voltage directly affects the input signal range, the switch ON resistance and the switching times of the part. The effects of the power supplies on these characteristics can be clearly seen from the characteristic curves in this data sheet.

Power-Supply Sequencing

When using CMOS devices, care must be taken to ensure correct power-supply sequencing. Incorrect power-supply sequencing can result in the device being subjected to stresses beyond those maximum ratings listed in the data sheet. Always sequence V_{DD} on first followed by V_{SS} and the logic signals. An external signal can then be safely presented to the source or drain of the switch.

MECHANICAL INFORMATION

Dimensions are shown in inches and (mm).

16-Pin Plastic DIP
(N-16)

0.840 (21.33)
0.745 (18.93)

0.280 (7.11)
0.240 (6.10)

0.325 (8.25)
0.300 (7.62)

0.195 (4.95)
0.115 (2.93)

PIN 1

0.060 (1.52)
0.015 (0.38)

0.210 (5.33)
MAX

0.160 (4.06)
0.115 (2.93)

0.130 (3.30) MIN

0.015 (0.381)
0.008 (0.204)

0.022 (0.558)
0.014 (0.356)

0.100 (2.54) BSC

0.070 (1.77)
0.045 (1.15)

SEATING PLANE
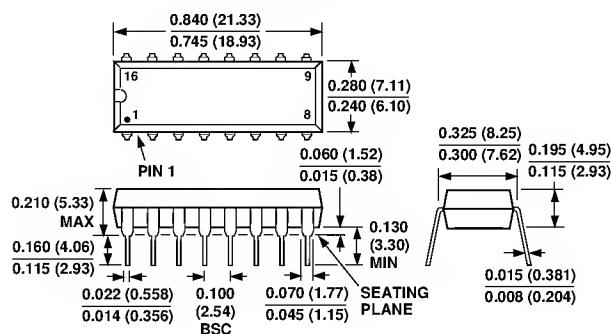
16-Pin Narrow Body SOIC
(R-16A)

0.3937 (10.00)
0.3859 (9.80)

0.1574 (4.00)
0.1497 (5.80)

0.2550 (6.20)
0.2284 (5.80)

PIN 1

0.0688 (1.75)
0.0532 (1.35)

0.0196 (0.50)
0.0099 (0.25) x 45°

0.0098 (0.25)
0.0040 (0.10)

SEATING PLANE

0.0500 (1.27) BSC

0.0192 (0.49)
0.0138 (0.35)

0.0099 (0.25)
0.0075 (0.19)

8°
0°

0.0500 (1.27)
0.0160 (0.41)

REV. 0